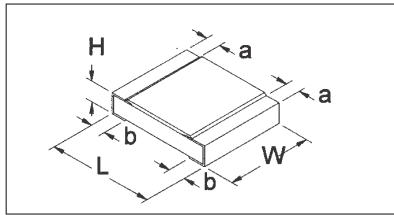


Thin Film Chip Resistors



FEATURES

- Surface Mount Devices (SMD)
- Precision Tolerances of $\pm 0.5\%$ to $\pm 0.1\%$
- Temperature Coefficients of $\pm 50\text{ppm}/^\circ\text{C}$ and $\pm 25\text{ppm}/^\circ\text{C}$
- Precision Performance
- Space Saving Construction

PERFORMANCE CHARACTERISTICS (Tested per Mil-STD-202)

Dimensions in mm

Electrical (Operating Temperature Range -55°C to $+155^\circ\text{C}$)

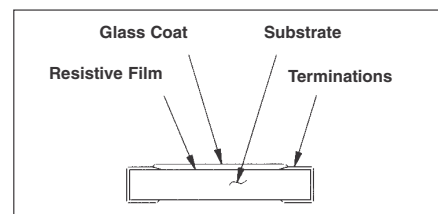
TYPE	Packaging Size	Power Rating (Watts)	Max. Working Voltage	Max. Overload Voltage	Resistance Temp. Coefficient	Resistance Range	Tolerance
RN10	0805	1/8 @ 70°C	150V	300V	$\pm 50\text{ppm}/^\circ\text{C}$ $\pm 25\text{ppm}/^\circ\text{C}$	100ohm - 787K 100Ohm - 100K	D = $\pm 0.5\%$ C = $\pm 0.25\%$, B = $\pm 0.1\%$
RN12	1206	1/8 @ 70°C	150V	300V	$\pm 50\text{ppm}/^\circ\text{C}$ $\pm 25\text{ppm}/^\circ\text{C}$	100ohm - 787K 49.9Ohm - 1M	D = $\pm 0.5\%$ C = $\pm 0.25\%$, B = $\pm 0.1\%$

ENVIRONMENTAL

	Specification	Typical	Test Method
Moisture Resistance, Thermal Shock	$\pm(0.25\%+0.05\Omega)$	$\leq 0.1\%$	JIS C 5202 7.4
Load Life	$\pm(0.5\%+0.05\Omega)$	$\leq 0.2\%$	JIS C 5202 7.10
Load Life in Moisture	$\pm(0.5\%+0.05\Omega)$	$\leq 0.25\%$	JIS C 5202 7.9
Resistance to Soldering Heat	$\pm(0.25\%+0.05\Omega)$	$\leq 0.05\%$	JIS C 5202 6.4, $260\pm 5^\circ\text{C}$, 10 sec.
Solderability	min. 95% coverage	$\geq 95\%$	JIS C 5202 6.5
Terminal Strength	$\pm(0.2\%+0.05\Omega)$	$\leq 0.05\%$	EIAJ RC-2609A 6.6
Dielectric Withstanding Voltage	$\pm(0.25\%+0.05\Omega)$	$\leq 0.05\%$	EIAJ RC-2609A 6.5 Test Voltage: $10 @ 150\text{VAC}$, RN12 @ 300VAC
Short Time Overload	$\pm(0.25\%+0.05\Omega)$	$\leq 0.05\%$	JIS C 5202 7.4
Insulation Resistance	1,000 meg minimum	$\geq 1,000$ meg	EIAJ RC-2609A 6.36

MATERIALS

Feature	Material	Remarks (Reference Only)
Substrate	Alumina Porcelain	Purity 96% min.
Resistive Film	Nickel-Chromium Film	20 Microns Thick
Coating	Boro-Silicated Acid Lead Glass	20 Microns Thick
Terminations	100% matte Tin (Electrical Plated) over Nickel (Electrical Plated) over AG-PD (Silver-Palladium [Glaze Printed])	3/5 Microns Thick 3/8 Microns Thick 8 Microns Thick



Dimensions in mm

Feature	RN10	RN12
L - Body Length	$.078 \pm .008$ (2.00 \pm 0.20)	$.122 \pm .004$ (3.10 \pm 0.10)
W - Body Width	$.049 \pm .008$ (1.25 \pm 0.20)	$.061 \pm .004$ (1.55 \pm 0.10)
H - Body Height	$.018 \pm .004$ (0.45 \pm 0.10)	$.021 \pm .004 / -.002$ (0.55 \pm 0.10/-0.05)
a - Top Termination	$.016 \pm .008$ (0.40 \pm 0.20)	$.018 \pm .008$ (0.45 \pm 0.20)
b - Bottom Termination	$.012 \pm .008 / -.004$ (0.30 \pm 0.20/-0.10)	$.012 \pm .008 / -.004$ (0.30 \pm 0.20/-0.10)

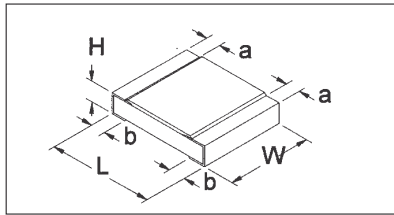
Notes: 1. Embossed taping available on RN12 only.

Ordering Information

Example: 0805 1/10 watt .1% 1k

RN	10	B	1001	CT
Thin Film	Wattage	Resistance	Tolerance *Note	Packaging (Tape & Reel)
<p>B = .1% C = .25% D = .50%</p>				

Thin Film Chip Resistors



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- Precision Performance
- Space Saving Construction

PERFORMANCE CHARACTERISTICS (Tested per Mil-STD-202)

Electrical (Operating Temperature Range -55°C to $+155^\circ\text{C}$)

Dimensions in mm

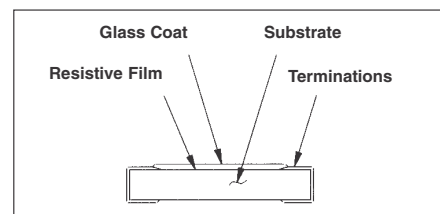
TYPE	Packaging Size	Power Rating (Watts)	Max. Working Voltage	Max. Overload Voltage	Resistance Temp. Coefficient	Resistance Range	Tolerance ¹
RN04	0402	1/16 @ 70°C	50V	100V	$\pm 50\text{ppm}/^\circ\text{C}$ $\pm 25\text{ppm}/^\circ\text{C}$	10 Ω - 97.6K 100 Ω - 100K	D = $\pm 0.5\%$ C = $\pm 0.25\%$, B = $\pm 0.1\%$
RN06	0603	1/10 @ 70°C	75V	150V	$\pm 50\text{ppm}/^\circ\text{C}$ $\pm 25\text{ppm}/^\circ\text{C}$	10 Ω - 97.6K 49.9 Ω - 360K	D = $\pm 0.5\%$ C = $\pm 0.25\%$, B = $\pm 0.1\%$

ENVIRONMENTAL

	Specification	Typical	Test Method
Moisture Resistance, Thermal Shock	$\pm(0.25\%+0.05\Omega)$	$\leq 0.1\%$	JIS C 5202 7.4
Load Life	$\pm(0.5\%+0.05\Omega)$	$\leq 0.2\%$	JIS C 5202 7.10
Load Life in Moisture	$\pm(0.5\%+0.05\Omega)$	$\leq 0.25\%$	JIS C 5202 7.9
Resistance to Soldering Heat	$\pm(0.25\%+0.05\Omega)$	$\leq 0.05\%$	JIS C 5202 6.4, $260\pm 5^\circ\text{C}$, 10 sec.
Solderability	min. 95% coverage	$\geq 95\%$	JIS C 5202 6.5
Terminal Strength	$\pm(0.2\%+0.05\Omega)$	$\leq 0.05\%$	EIAJ RC-2609A 6.6
Dielectric Withstanding Voltage	$\pm(0.25\%+0.05\Omega)$	$\leq 0.05\%$	EIAJ RC-2609A 6.5 Test Voltage: 10@ 150VAC, RN12 @ 300VAC
Short Time Overload	$\pm(0.25\%+0.05\Omega)$	$\leq 0.05\%$	JIS C 5202 7.4
Insulation Resistance	1,000 meg minimum	$\geq 1,000$ meg	EIAJ RC-2609A 6.36

MATERIALS

Feature	Material	Remarks (Reference Only)
Substrate	Alumina Porcelain	Purity 96% min.
Resistive Film	Nickel-Chromium Film	20 Microns Thick
Coating	Boro-Silicated Acid Lead Glass	20 Microns Thick
Terminations	100% matte Tin (Electrical Plated) over Nickel (Electrical Plated) over AG-PD (Silver-Palladium [Glaze Printed])	3/8 Microns Thick 3/5 Microns Thick 8 Microns Thick



Dimensions in mm

Feature	RN04	RN06
L - Body Length	1.00 ± 0.05	1.60 ± 0.20
W - Body Width	0.50 ± 0.05	0.80 ± 0.20
H - Body Height	0.35 ± 0.05	0.40 ± 0.10
a - Top Termination	0.20 ± 0.10	0.30 ± 0.20
b - Bottom Termination	0.20 ± 0.10	0.30 ± 0.20

Notes: 1. Embossed taping available on RN12 only.

Ordering Information

Example: 0805 1/10 watt .1% 1k

RN	10	B	1001	CT
Thin Film	Wattage	Resistance	Tolerance *Note	Packaging (Tape & Reel)
			B = .1%	
			C = .25%	
			D = .50%	